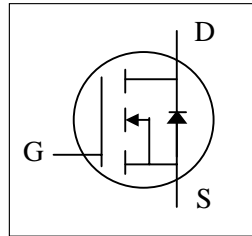




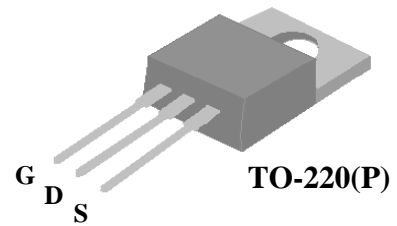
- ▼ 100% R_g & UIS Test
- ▼ Simple Drive Requirement
- ▼ Lower On-resistance
- ▼ RoHS Compliant & Halogen-Free



BV _{DSS}	120V
R _{DS(ON)}	7.6mΩ
I _D	100A

Description

AP12N7R6 series are from Advanced Power innovated design and silicon process technology to achieve the lowest possible on-resistance and fast switching performance. It provides the designer with an extreme efficient device for use in a wide range of power applications.



The TO-220 package is widely preferred for all commercial-industrial through hole applications. The low thermal resistance and low package cost contribute to the worldwide popular package.

Absolute Maximum Ratings @T_j=25°C (unless otherwise specified)

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	120	V
V _{GS}	Gate-Source Voltage	+20	V
I _D @T _C =25°C	Drain Current, V _{GS} @ 10V	100	A
I _D @T _C =100°C	Drain Current, V _{GS} @ 10V	63	A
I _{DM}	Pulsed Drain Current ¹	320	A
P _D @T _C =25°C	Total Power Dissipation	147	W
P _D @T _A =25°C	Total Power Dissipation	2	W
E _{AS}	Single Pulse Avalanche Energy ³	125	mJ
T _{STG}	Storage Temperature Range	-55 to 150	°C
T _J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Value	Units
R _{thj-c}	Maximum Thermal Resistance, Junction-case	0.85	°C/W
R _{thj-a}	Maximum Thermal Resistance, Junction-ambient	62	°C/W



AP12N7R6P

Electrical Characteristics @T_j=25°C(unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	120	-	-	V
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V _{GS} =10V, I _D =60A	-	-	7.6	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250uA	2	-	5	V
g _{fs}	Forward Transconductance	V _{DS} =5V, I _D =60A	-	50	-	S
I _{DSS}	Drain-Source Leakage Current	V _{DS} =96V, V _{GS} =0V	-	-	25	uA
I _{GSS}	Gate-Source Leakage	V _{GS} =±20V, V _{DS} =0V	-	-	+100	nA
Q _g	Total Gate Charge	I _D =60A	-	77	123.2	nC
Q _{gs}	Gate-Source Charge	V _{DS} =60V	-	30	-	nC
Q _{gd}	Gate-Drain ("Miller") Charge	V _{GS} =10V	-	21	-	nC
t _{d(on)}	Turn-on Delay Time	V _{DS} =60V	-	19	-	ns
t _r	Rise Time	I _D =60A	-	97	-	ns
t _{d(off)}	Turn-off Delay Time	R _G =1.6 Ω	-	30	-	ns
t _f	Fall Time	V _{GS} =10V	-	11	-	ns
C _{iss}	Input Capacitance	V _{GS} =0V	-	4800	7680	pF
C _{oss}	Output Capacitance	V _{DS} =60V	-	630	-	pF
C _{rss}	Reverse Transfer Capacitance	f=1.0MHz	-	11	-	pF
R _g	Gate Resistance	f=1.0MHz	-	1.4	2.8	Ω

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V _{SD}	Forward On Voltage ²	I _S =60A, V _{GS} =0V	-	-	1.3	V
t _{rr}	Reverse Recovery Time	I _S =60A, V _{GS} =0V	-	65	-	ns
Q _{rr}	Reverse Recovery Charge	di/dt=100A/μs	-	92	-	nC

Notes:

- 1.Pulse width limited by Max. junction temperature.
- 2.Pulse test
- 3.Starting T_j=25°C , V_{DD}=50V , L=0.1mH , R_G=25Ω , V_{GS}=10V

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

USE OF THIS PRODUCT AS A CRITICAL COMPONENT IN LIFE SUPPORT OR OTHER SIMILAR SYSTEMS IS NOT AUTHORIZED.

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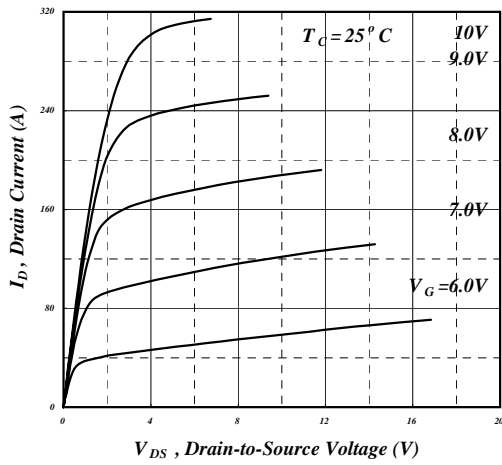


Fig 1. Typical Output Characteristics

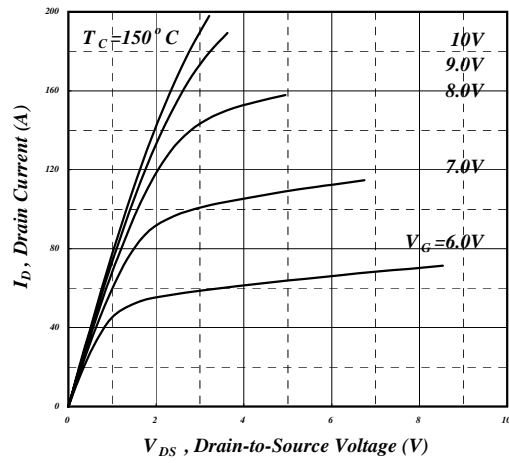


Fig 2. Typical Output Characteristics

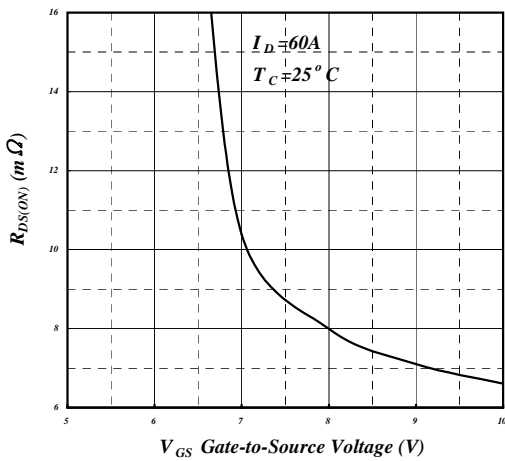


Fig 3. On-Resistance v.s. Gate Voltage

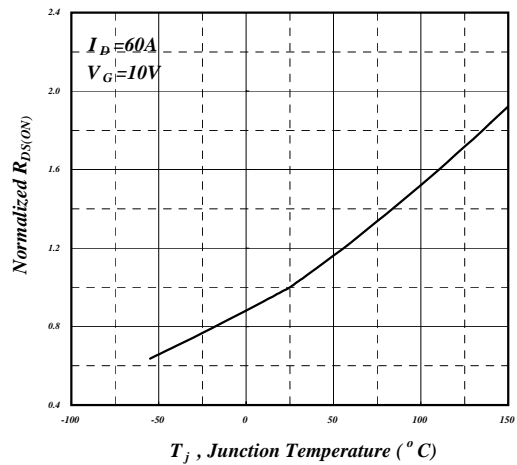


Fig 4. Normalized On-Resistance v.s. Junction Temperature

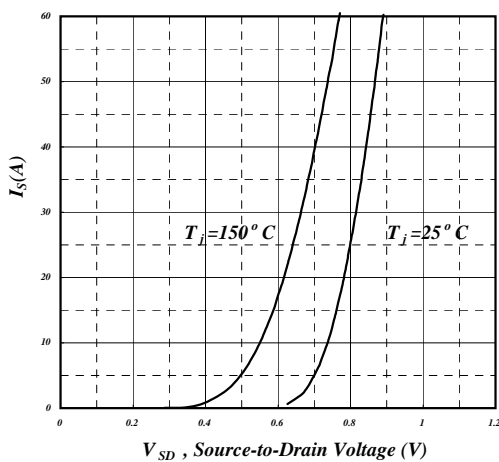


Fig 5. Forward Characteristic of Reverse Diode

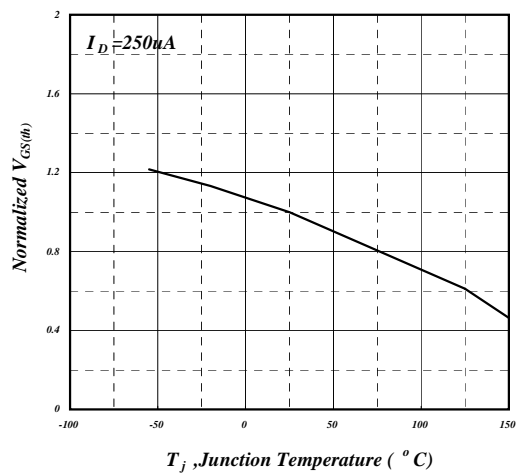


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

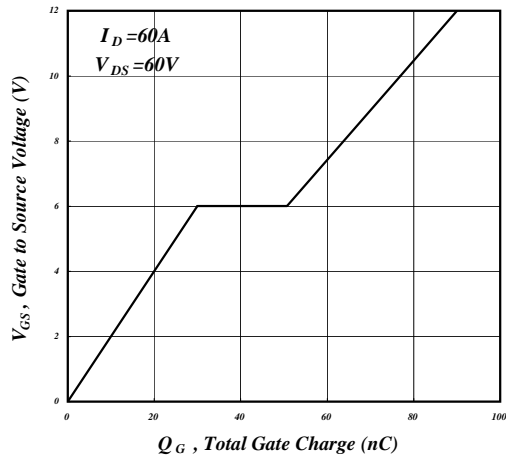


Fig 7. Gate Charge Characteristics

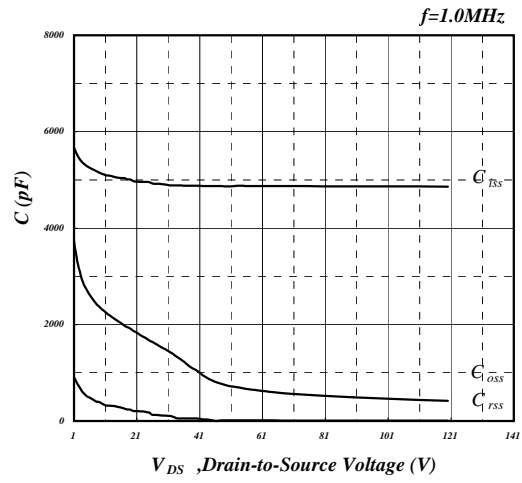


Fig 8. Typical Capacitance Characteristics

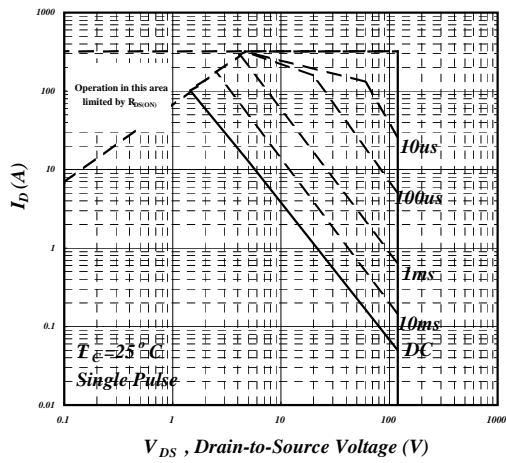


Fig 9. Maximum Safe Operating Area

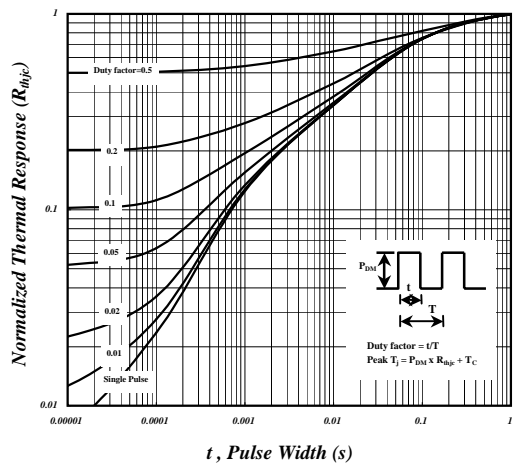


Fig 10. Effective Transient Thermal Impedance

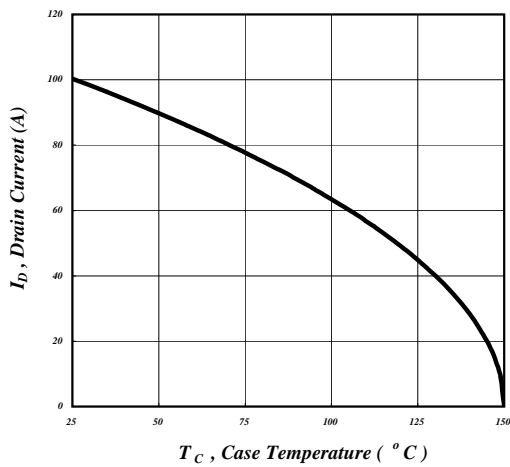


Fig 11. Drain Current v.s. Case Temperature

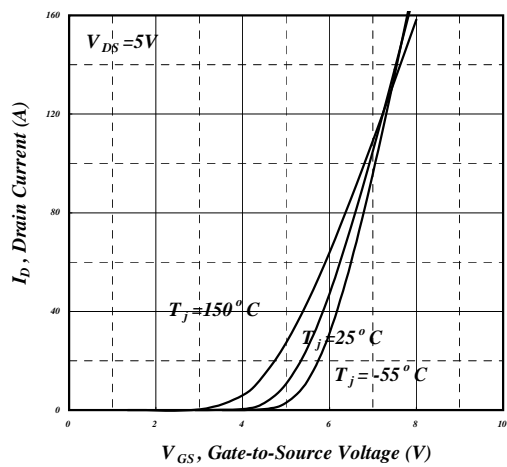


Fig 12. Transfer Characteristics

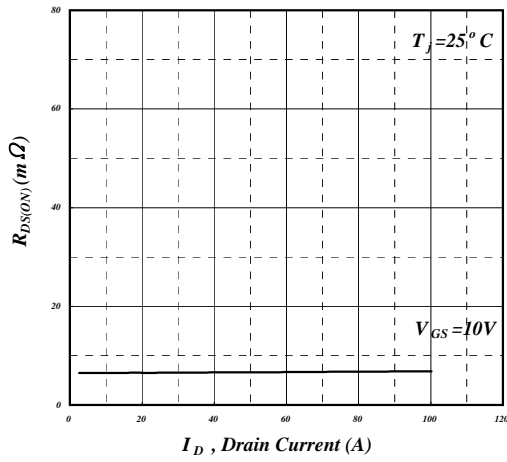


Fig 13. Typ. Drain-Source on State Resistance

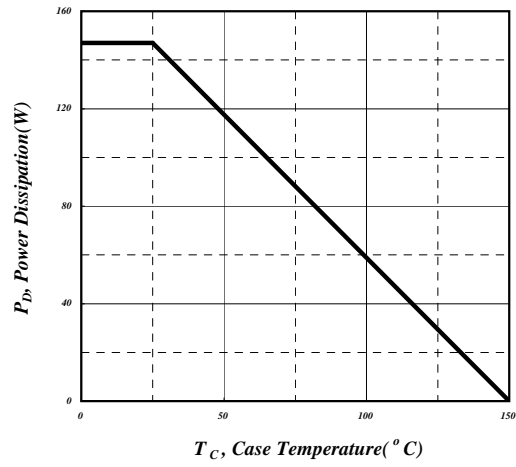


Fig 14. Total Power Dissipation



AP12N7R6P

MARKING INFORMATION

